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# TFT | CHARACTER | UWVD | FSC | SEGMENT | CUSTOM | REPLACEMENT

# **TFT Display Module**

Part Number E28RA-I-CW600-C

#### Overview:

- 2.8-inch TFT (50.5x69.7 I I)
- 240号20 ix纤维
- 3/4SPI+ 356455500 WD. LITT 1 LLAT
- 8/9/16/18-bit MCU Interface
- 3/4-wire SPI Interface
- All View

- Transmissive, IPS
- Wide Temperature
- Capacitive Touch Panel
- 600 nits
- TFT IC: ST7789V
- RoHS Compliant



#### **Description**

This is a color active matrix TFT (Thin Film Transistor) LCD (Liquid Crystal Display) that uses amorphous silicon TFT as a switching device. This model is composed of a transmissive type TFT LCD Panel, driver circuit, capacitive touch panel, and a backlight unit. The resolution of the 2.8" TFT LCD contains 240(RGB)x320 pixels and can display up to 262k colors.

#### **TFT Features**

Low Input Voltage: 3.3V Display Colors: 65k/262k Interface: 8/9/16/18-bit MCU 3/4SPI+16/18-bitRGB

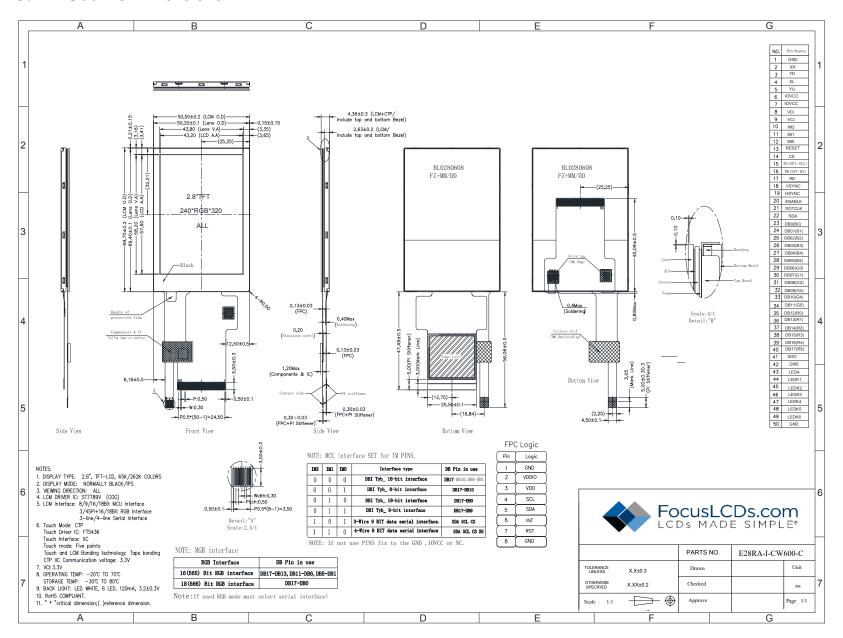
3/4-wire Serial

General Information Items	Specification  Main Panel	Unit	Note
TFT Display area (AA)	43.20(H) x 57.60(V) (2.8 inch)	mm	-
Driver Element	TFT active matrix	-	-
Display Colors	65k/262k	colors	-
Number of pixels	240(RGB)x320	dots	-
TFT Pixel arrangement	RGB vertical stripe	-	-
Pixel Pitch	0.18(H)x0.18(V)	mm	-
Viewing angle	ALL	o'clock	-
TFT Controller IC	ST7789V	-	-
TFT Interface	MCU, RGB, SPI	-	-
Display mode	Transmissive/ Normally Black	-	-
Operating temperature	-20 <b>~</b> +70	°C	-
Storage temperature	-30 <b>~</b> +80	°C	-
CTP IC	FT5439	-	-
CTP Interface	I2C	°C	-
Touch Mode	5 points and gestures	°C	-

## **Mechanical Information**

	Item	Min	Тур.	Max	Unit	Note
	Horizontal (H)		50.50		mm	-
Module Size	Vertical (V)		69.70		mm	-
	Depth (D)		4.36		mm	-
	Weight		30		g	

#### 3. Outline Dimensions

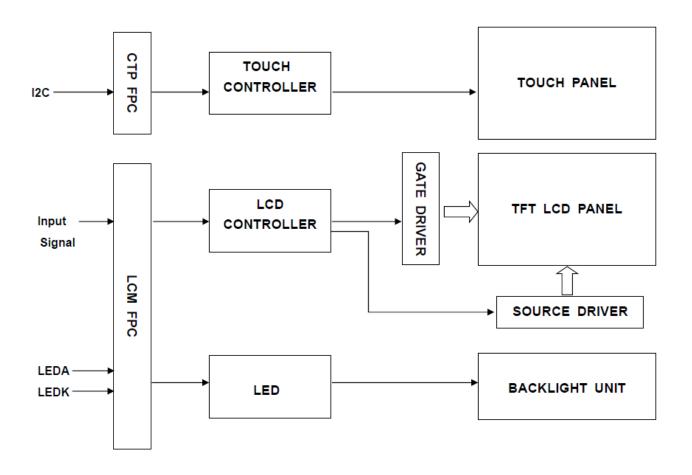


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## 2. Block Diagram





## Input Terminal Pin Assignment 3.

## 3.1

NO.	Symbol	Description					I/O		
1	GND	Ground							
2	XR (NC)	Touch panel right glass terminal					A/D A/D		
3	YD (NC)		Touch panel bottom film terminal						
4	XL (NC)		Touch panel left glass terminal						
5	YU (NC)	Touch panel top film terr					A/D		
6-7	IOVCC	Supply voltage (1.65-3.3)	V)				P		
8-9	VCI	Supply voltage (3.3V)			· · · · · · · · · · · · · · · · · · ·		P		
			Interface selection IM2 IM1 IM0 Pins used						
		DBI 8-bit	0	0	0	DB7-DB0	-		
	IM2	DBI 16-bit	0	1	0	DB15-DB0	_		
10-12	IM1	DBI 9-bit	0	0	1	DB8-DB0	I		
	IM0	DBI 18-bit	0	1	1	DB17-DB0			
		3-wire, 9-bit SPI	1	0	1	SDA SCL CS	_		
			4-wire, 8-bit SPI 1 1 0 SDA SCL CS RS						
13	RESET	Reset signal of the device. Must be applied to properly initialize the device.							
14	CS	Chip select pin. When not used this pin can be fixed low.					I		
15	RS(SPI_SCL)	Data or command signal for the parallel MCU interface. RS=1: data selected, RS=0: command selected. The clock for the serial interface. If not used, pin to VCI or GND.					I		
16	WR(SPI_RS)	Write signal in the parallethe 4-wire serial interface			-	neter select signal for	I		
17	RD	Read signal for the MCU	parallel int	terface. If not	used, pin to	VCI or GND.	О		
18	VSYNC	Frame synchronizing sign	nal for the F	RGB interface	e. If not used,	pin to VCI or GND.	I		
19	HSYNC	Line synchronizing signa	l for the RO	GB interface.	If not used, 1	oin to VCI or GND.	I		
20	ENABLE	Data enable signal for the	RGB inter	face. If not u	sed, pin to V	CI or GND.	I		
21	DOTCLK	Dot clock signal for the I					I		
22	SDA	Serial input signal. The da	ata is applie				I		
23-40	DB0-DB17	18-bit parallel bi-directio when not used.	18-bit parallel bi-directional data but for the RGB and MCU interfaces. Fix to GND						
41	SDO	Serial data output for the SPI interface.					I		
42	GND	Ground					P		
43	LEDA	Anode pin of the backlig					P		
44-49	LEDK1-K6	Cathode pins of the backlight					P		
50	GND	Cathode pin of the backli	ght				P		
I. In	nut O. Outnut P	· Down							

I: Input, O: Output, P: Power

#### 3.2 **CTP**

NO.	Symbol	Description	I/O
1	GND	Ground	P
2	VDDIO	I/O power supply voltage	P
3	VDD	Supply voltage	P
4	SCL	I2C clock input	I
5	SDA	I2C data input and output	I/O
6	INT	External interrupt signal to the host	I
7	RST	External reset, active low	I
8	GND	Ground	О



# 4. LCD Optical Characteristics

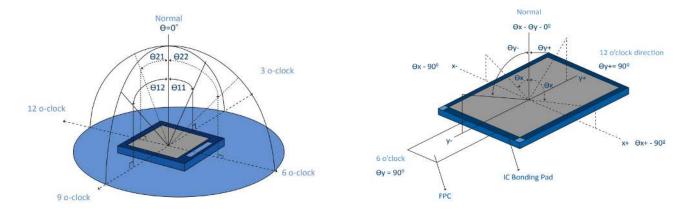
## **4.1** Optical Specifications

Item	pecification	Symbol	Condition	Min	Тур.	Max	Unit	Note
Color Gamut		S%	Condition	60	65		%	(3)
Contrast R	atio	CR		600	800		%	(2)
Response Time	Rising Falling	TR+TF			30	40	ms	(4)
	VV/1-:4-	$W_{X}$	$\theta = 0$	0.237	0.277	0.317		
	White	$W_{Y}$	Normal viewing angle	0.256	0.296	0.336		(5)(6)
	Red	$R_X$		0.577	0.617	0.657		
Color Filter		$R_{Y}$		0.303	0.343	0.383		
Chromaticity	C	$G_X$		0.261	0.301	0.341		(5)(6)
	Green	$G_{Y}$		0.545	0.585	0.625		
	DI	$B_X$		0.108	0.148	0.188		
	Blue	$B_{Y}$		0.012	0.052	0.092		
		ΘL			80			
77:: A1-	Hor.	ΘR	CR≥10		80		1	(1)(6)
Viewing Angle		ΘΤ			80		degrees	(1)(6)
	Ver.	ΘΒ			80			
Option View Direction				ALL				(1)



#### **Optical Specification Reference Notes:**

(1) Definition of Viewing Angle: The viewing angle is the angle at which the contrast ratio is greater than 10. The viewing angles are determined for the horizontal or 3,9 o'clock direction and the vertical or 6,12 o'clock direction with respect to the optical axis which is normal to the LCD surface.

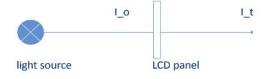


(2) Definition of Contrast Ratio (Cr): measured at the center point of panel. The contrast ratio (Cr) measured on a module, is the ratio between the luminance (Lw) in a full white area (R=G=B=1) and the luminance (Ld) in a dark area (R=G=B=0).

$$Cr = \frac{Lw}{Ld}$$

(3) Definition of transmittance (T%): The transmittance of the panel including the polarizers is measured with electrical driving. The equation for transmittance Tr is:

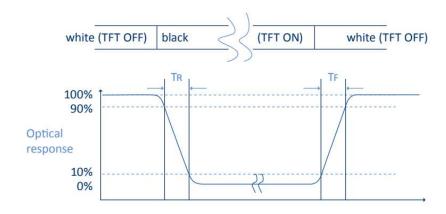
$$Tr = \frac{It}{Io} x 100\%$$



Io = the brightness of the light source.

It = the brightness after panel transmission

(4) Definition of Response Time (Tr, Tf): The rise time 'Tr' is defined as the time for luminance to change from 90% to 10% as a result of a change of the electrical condition. The fall time 'Tf' is defined as the time for luminance to change from 10% to 90% as a result of a change of the electrical condition.





#### (5) Definition of Color Gamut:

Measuring machine CFT-01. NTSC's Primaries: R(x,y,Y),G(x,y,Y), B(x,y,Y). FPM520 of Westar Display Technologies, INC., which utilized SR-3 for Chromaticity and BM-5A for other optical characteristics. The color chromaticity shall be calculated from the spectral data measured with all pixels first in red, green, blue and white. Measurements shall be made at the center of the panel.

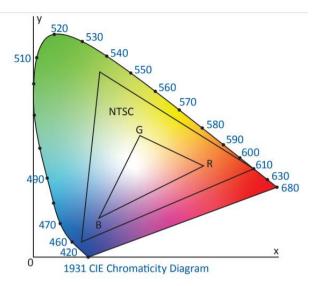
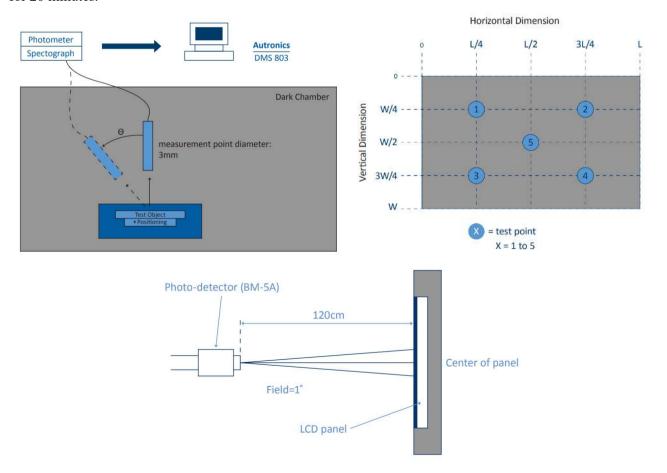


Fig. 1931 CIE chromacity diagram

Color gamut:  $S = \frac{\text{Area of RGB triangle}}{\text{Area of NTSC triangle}} \times 100\%$ 

#### (6) Definition of Optical Measurement Setup:

The LCD module should be stabilized at a given temperature for 20 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting backlight for 20 minutes.





## 5. TFT Electrical Characteristics

5.1 Absolute Maximum Rating (Ta=25 °C, VSS=0V)

Characteristics	Symbol	Min	Max	Unit
Digital Supply Voltage	VDD	-0.3	4.6	V
Digital Interface Supply Voltage	IOVCC	-0.3	4.6	
Operating Temperature	TOP	-20	+70	°C
Storage Temperature	TST	-30	+80	°C

NOTE: If the absolute maximum rating of the above parameters is exceeded, even momentarily, the quality of the product may be degraded. Absolute maximum ratings specify the values which the product may be physically damaged if exceeded. Be sure to use the product within the range of the absolute maximum ratings.

#### **5.2** DC Electrical Characteristics

Characteristics	Symbol	Min	Тур.	Max	Unit	Note
Digital Supply Voltage	VCI	2.5	3.3	3.6	V	
Digital Interface Supply Voltage	IOVCC	1.65	1.8	3.3	V	
Normal Mode Current	IDD		8		mA	
Level Input Voltage	VIH	0.7IOVCC		IOVCC	V	
Level input voltage	VIL	GND		0.3IOVCC	V	
Level Output Voltage	VOH	0.8IOVCC		IOVCC	V	
Level Sulput Vollage	VOL	GND		0.2IOVCC	V	



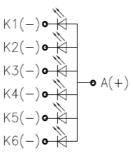
#### 5.3 LED Backlight Characteristics

Item	Symbol	Min	Тур.	Max	Unit	Note
Forward Current	IF	90	120		mA	
Forward Voltage	VF		3.2		V	
LCM Luminance	LV	550	600		cd/m2	Note 3
LED lifetime	Hr		50000		hour	Note1 & 2
Uniformity	AVg	80			%	Note 3

The back-light system is edge-lighting type with 6 white LEDs.

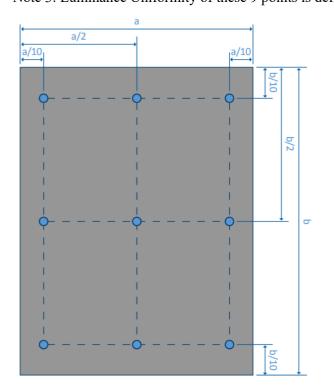
Note 1: LED lifetime (Hr) can be defined as the time in which it continues to operate under the condition:  $Ta=25\pm3$  °C, typical IL value indicated in the above table until the brightness becomes less than 50%.

Note 2: The "LED lifetime" is defined as the module brightness decrease to 50% original brightness at Ta=25°C and IL=120mA. The LED lifetime could be decreased if operating IL is larger than 120mA. The constant current driving method is suggested.



**Backlight LED Circuit** 

Note 3: Luminance Uniformity of these 9 points is defined as below:



$$Luminance = (\underbrace{Total\ Luminance\ of\ 9\ points}_{Q})$$

Uniformity = minimum luminance in 9 points(1-9) maximum luminance in 9 points(1-9)



## 6. AC Characteristic

### **6.1** Parallel RGB Interface Characteristics

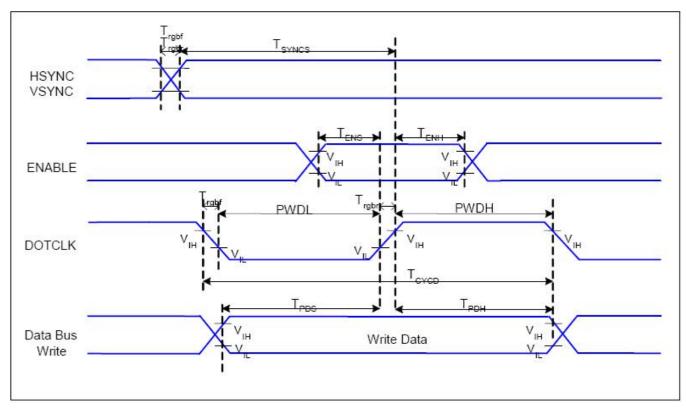


Figure 6.1: Parallel RGB Interface Timing Diagram

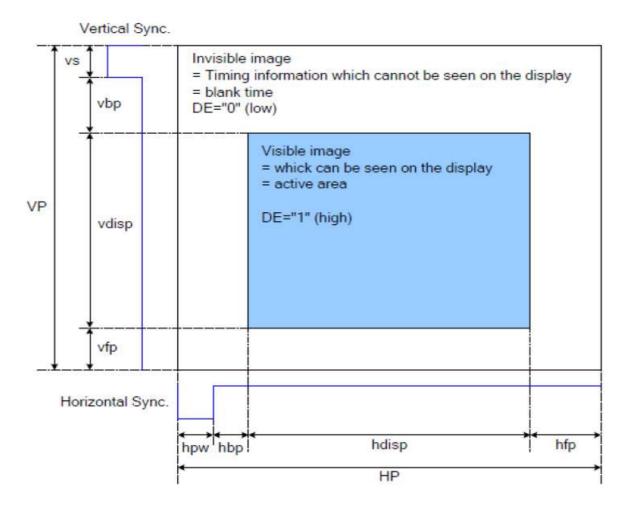
Signal	Symbol	Parameter	Min	Max	Unit	Description
HSYNC, VSYNC	$T_{SYNCS}$	VSYNC, HSYNC Setup Time	30	-	ns	
	$T_{ENS}$	Enable Setup Time	25	-	ns	
ENABLE	$T_{ENH}$	Enable Hold Time	25	-	ns	
	PWDH	DOTCLK High-level Pulse Width	60	-	ns	
	PWDL	DOTCLK Low-level Pulse Width	60	-	ns	
DOTCLK	$T_{CYCD}$	DOTCLK Cycle Time	120	-	ns	
	$T_{RGHR}, T_{RGHF}$	DOTCLK Rise/Fall Time	-	20	ns	
DB	$T_{\mathrm{DB}S}$	DB Data Setup Time	50	_	ns	
	$T_{\mathrm{DB}H}$	DB Data Hold Time	50	_	ns	

Table 6.1: Parallel RGB Interface Timing Characteristics



### **6.2** Timing Tables

The display operation via the RGB interface is synchronized with the VSYNC, HSYNC and DOTCLK signals. The data can be written only within the specified area with low power consumption by using the window address function. The back porch and front porch are used to set the RGB interface timing signals.



Parameter	Symbol	Min	Тур	Max	Unit
DCLK cycle time	delk	120	-		ns
Horizontal sync width	hpw	2	10	16	delk
Horizontal back porch	hbp	2	20	24	delk
Horizontal front porch	hfp	2	10	16	delk
Vertical sync width	VS	1	2	4	Line
Vertical back porch	vbp	1	2		Line
Vertical front porch	vfp	3	4		Line

Table 6.2: RGB Interface Timing Table



## 6.3 Display Serial Interface Characteristics (3-line SPI system)

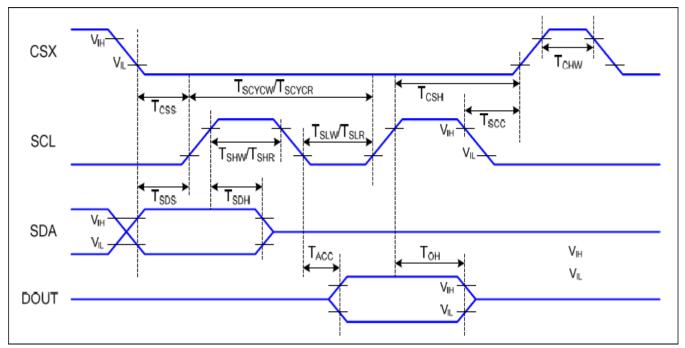


Figure 6.3: Serial Interface 3-SPI Timing Diagram

 $VDDI = 1.64 \ to \ 3.3V, \ VDD = 2.4 \ to \ 3.3V, \ AGND = DGND = 0V, \ Ta = -30 \ to \ 70 \ C^o$ 

Signal	Symbol	Parameter	Min	Max	Unit	Description
	$T_{CSS}$	Chip select setup time (write)	15		ns	
	$T_{CSH}$	Chip select hold time (write)	15		ns	
CSX	$T_{CSS}$	Chip select setup time (read)	60		ns	
	$T_{SCC}$	Chip select hold time (read)	65		ns	
	$T_{CHW}$	Chip select "H" pulse width	40		ns	
	$T_{SCYCW}$	Serial clock cycle (write)	66		ns	
	$T_{SHW}$	SCL "H" pulse width (write)	15		ns	
CCI	$T_{SLW}$	SCL "L" width (write)	15		ns	
SCL	$T_{SCYCR}$	Serial clock cycle (read)	150		ns	
	$T_{SHR}$	SCL "H" pulse width (read)	60		ns	
	$T_{SLR}$	SCL "L" pulse width (read)	60		ns	
CDA (DINI)	$T_{SDS}$	Data setup time	30			
SDA (DIN)	$T_{\mathrm{SDH}}$	Data hold time	30		ns	
	$T_{ACC}$	Access time	10	50		For max
SDA (DOUT)	$T_{OH}$	Output disable time	15	50	ns	CL=30pF For min CL=8pF

Table 6.3: 3-line Serial Interface Timing Characteristics

Note: The rising time and falling time (Tr, Tf) of input signal are specified at 15 ns or less. Logic high and low levels are specified as 30% and 70% of VDDI for Input signals



## 6.4 Display Serial Interface Characteristics (4-line SPI serial)

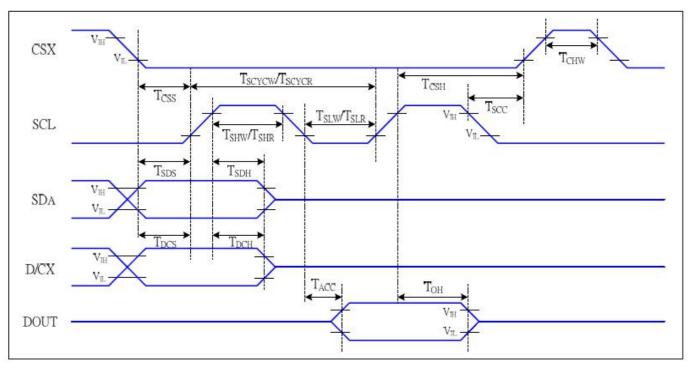


Figure 6.4: Serial Interface 4-SPI Timing Diagram

Signal	Symbol	Parameter	Min	Max	Unit	Description
	$T_{CSS}$	Chip select setup time (write)	15		ns	
	$T_{CSH}$	Chip select hold time (write)	15		ns	
CSX	$T_{CSS}$	Chip select setup time (read)	60		ns	
	$T_{SCC}$	Chip select hold time (read)	65		ns	
	$T_{CHW}$	Chip select "H" pulse width	40		ns	
	$T_{SCYCW}$	Serial clock cycle (write)	66		ns	white commond &
	$T_{SHW}$	SCL "H" pulse width (write)	15		ns	write command &
CCI	$T_{SLW}$	SCL "L" width (write)	15		ns	data ram
SCL	$T_{SCYCR}$	Serial clock cycle (read)	150		ns	1 1 0
	$T_{SHR}$	SCL "H" pulse width (read)	60		ns	read command &
	$T_{SLR}$	SCL "L" pulse width (read)	60		ns	data ram
D/CX	$T_{DCS}$	D/CX setup time	10		ns	
D/CX	$T_{DCH}$	D/CX hold time	10		ns	
CDA (DIM)	$T_{SDS}$	Data setup time	10		ns	
SDA (DIN)	$T_{\mathrm{SDH}}$	Data hold time	10		ns	
DOUT	$T_{ACC}$	Access time	10	50	ns	For max
D001	$T_{\mathrm{OH}}$	Output disable time	15	50	ns	CL=30pF For

Table 6.5: 4-line Serial Interface Timing Characteristics

 $\min CL = 8pF$ 

Note: The rising time and falling time (Tr, Tf) of input signal are specified at 15 ns or less. Logic high and low levels are specified as 30% and 70% of VDDI for Input signals.

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### 6.5 8080 Series MCU Parallel Interface Characteristics: 18/16/9/8-bit Bus

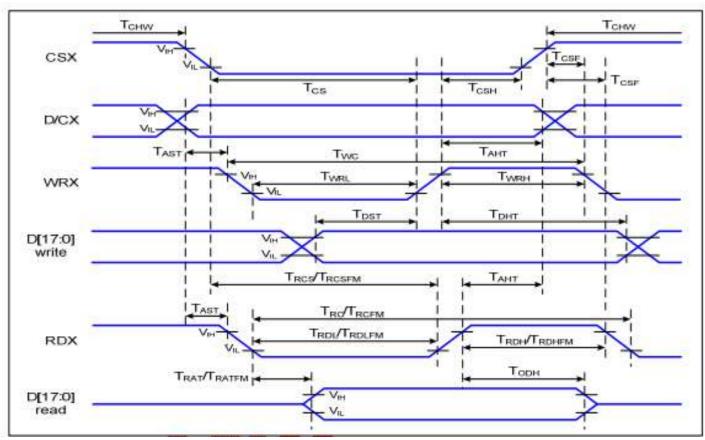


Figure 6.5: Parallel Interface Timing Characteristics (8080-Series MCU Interface)

Signal	Symbol	Parameter	Min	Max	Unit	Description
D/CX	$T_{AST}$	Address setup time	0	-	ns	
	$T_{AHT}$	Address hold time (Write/Read)	10	-	ns	
CSX	$T_{CHW}$	Chip select "H" pulse width	0	-	ns	
	$T_{CS}$	Chip select setup time (Write)	15	-	ns	
	$T_{RCS}$	Chip select setup time (Read ID)	45	-	ns	
	$T_{RCSFM}$	Chip select setup time (Read FM)	355	-	ns	
	$T_{CSF}$	Chip select wait time (Write/Read)	10	-	ns	
	$T_{CSH}$	Chip select hold time	10	-	ns	
WRX	$T_{WC}$	Write cycle	66	-	ns	
	$T_{WRH}$	Control pulse "H" duration	15	-	ns	
	$T_{\mathrm{WRL}}$	Control pulse "L" duration	15		ns	
RDX (ID)	$T_{RC}$	Read cycle (ID)	160	-	ns	
	$T_{RDH}$	Control pulse "H" duration (ID)	90	-	ns	
	$T_{RDL}$	Control pulse "L" duration	45	-	ns	
RDX (FM)	$T_{RCFM}$	Read cycle (FM)	450	-	ns	
	$T_{RDHFM}$	Control pulse "H" duration (FM)	90	-	ns	
	$T_{RDLFM}$	Control pulse "L" duration (FM)	355	-	ns	
D[17:0]	$T_{DST}$	Write data setup time	10	-	ns	
D[15:0],	$T_{DHT}$	Write data hold time	10	-	ns	For max CL=30pF
D[8:0],	$T_{RAT}$	Read access time (ID)	-	40	ns	]
D[7:0]	$T_{RATFM}$	Read access time (FM)	-	340	ns	For min CL=8pF
	$T_{ROD}$	Output disable time	20	80	ns	

Table 6.5: 8080 Series MCU Parallel Timing Characteristics



#### 6.3 Reset Timing

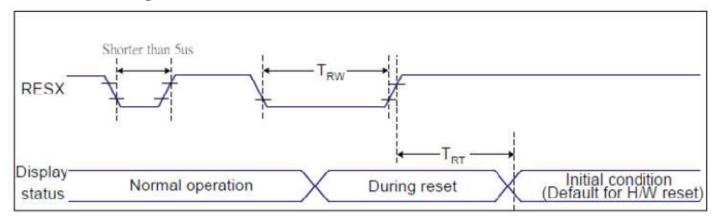


Figure 6.6: Reset Timing Diagram

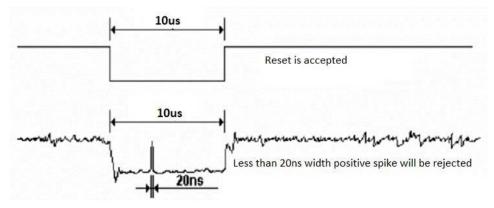
Related Pins	Symbol	Parameter	Min	Max	Unit
RESX	TRW	Reset pulse duration	10	-	us
	TDT	D t 1	-	5 (Note 1,5)	ms
	TRT	Reset cancel		120 (Note 1, 6, 7)	ms

#### Notes:

- 1. The reset cancel includes also required time for loading ID bytes, VCOM setting and other settings from NVM (or similar device) to registers. This loading is done every time when there is HW reset cancel time (tRT) within 5ms after a rising edge of RESX.
- 2. Spike due to an electrostatic discharge on RESX line does not because irregular system reset according to the table below:

RESX Pulse	Action
Shorter than 5us	Reset Rejected
Longer than 9us	Reset
Between 5us and 9 us	Reset starts

- 3. During the resetting period, the display will be blanked (the display is entering blanking sequence, which maximum time is 120ms, when reset starts in Sleep Out mode. The display remains the blank state in Sleep in mode) and then return to Default condition for Hardware Reset.
- 4. Spike Rejection also applies during a valid reset pulse as shown below:



- 5. When Reset applied during Sleep In Mode.
- 6. When Reset applied during Sleep Out Mode.
- 7. It is necessary to wait 5ms after releasing RESX before sending commands. Also Sleep Out command cannot be sent for 120ms.



### 7. CTP Electrical Characteristics

### 7.1 Absolute Maximum Rating

ltem	Symbol	Min	Max	Unit	Note
Power Supply Voltage	VDD	2.7	3.6	V	1
I/O Digital Voltage	VDDIO	1.8	3.6	V	1
Operating Temperature	T <sub>OP</sub>	-30	+85	°C	-
Storage Temperature	T <sub>ST</sub>	-30	+85	°C	-

Note: If used beyond the absolute maximum ratings, FT5436 may permanently damage. It is strongly recommended that the device be used within the electrical characteristics in normal operations. If exposed to the condition not within the electrical characteristics, it may affect the reliability of the device.

### 7.2 DC Electrical Characteristics (Ta=25°C)

Item	Symbol	Condition	Min	Тур.	Max	Unit	Note
Digital supply voltage	VDD		2.7	3.3	3.47	V	
I/O Digital supply voltage	VDDIO		1.8		3.6	V	
Normal operation mode current consumption	l <sub>OPr</sub>	VDD=2.7V		11		mA	
Monitor mode current consumption	I <sub>mon</sub>	Ta=25°C MCLK=17.5M		0.43		mA	
Sleep mode current consumption	I <sub>sip</sub>	Hz		42		uA	
Loval innut valtage	$V_{IH}$		0.7VDDIO		VDDIO	٧	
Level input voltage	$V_{IL}$		-0.3		0.3VDDIO	٧	
La alla La La La la alla a	VOH	I <sub>OH</sub> =-0.1mA	0.7VDDIO			٧	
Level output voltage	$V_{OL}$	I <sub>OL</sub> =0.1mA			0.3VDIOD	V	

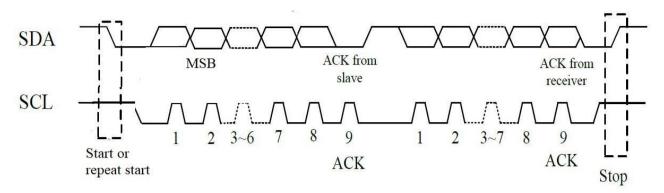
#### 7.3 AC Characteristics

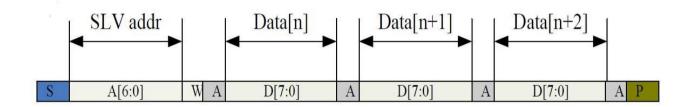
Item	Symbol	Test Condition	Min	Тур.	Max	Unit	Note
OSC clock 1	fosc1	VDDA=2.7V; Ta=25°C	49	50	51	MHz	
Sensor acceptable clock	ftx	VDDA=2.8V; Ta=25°C	50	150	400	kHz	
Sensor output rise time	Ttxr	VDDA=2.8V; Ta=25°C	-	210	1	ns	
Sensor output fall time	Ttxf	VDDA=2.8V; Ta=25°C	-	210	-	ns	
Sensor input voltage	Trxi	VDDA=2.8V; Ta=25°C	1.2	-	1.6	V	

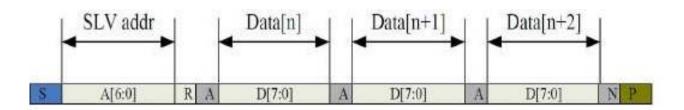


#### 7.4 I2C Interface

The I2C is always configured in the slave mode. The data transfer format is shown below.







The following table lists the meanings of the mnemonics used in the above figures.

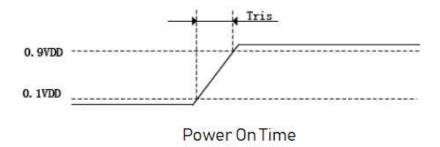
Mnemonics	Description
S	I2C start or I2C restart
A [6:0]	Slave address
R/W	Read/Write bit, '1' for read, '0' for write
A(N)	ACK(NACK)
Р	Stop: the indication of the end of a packet (if this bit is missing, S will indicate the end of the current packet and the beginning of the next packet)

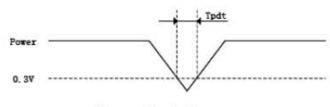
#### **I2C Interface Timing Characteristics**

Parameter	Min	Max	Unit
SCL frequency	0	400	kHz
Bus free time between a stop and start condition	1.3	-	us
Hold time (repeated) start condition	0.6	-	us
Data setup time	100	-	us
Setup time for a repeated start condition	0.6	-	us
Setup time for stop condition	0.6	-	us

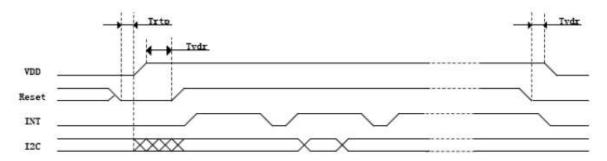


## 7.5 Power ON/Reset Sequence





Power Cycle Requirement



Power on Sequence

Parameter	Description	Min	Max	Units
Tris	Rise time from 0.1VDD to 0.9VDD		5	ms
Tpdt	Time of voltage being below 0.3V	5	1	ms
Trtp	Time of resetting low before powering on	100	1	us
Tvdr	Reset time	1	1	ms
Trsi	Time of starting to report point after resetting		200	ms

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## 8. Cautions and Handling Precautions

#### 8.1 Handling and Operating the Module

- 1. When the module is assembled, it should be attached to the system firmly. Do not warp or twist the module during assembly work.
- 2. Protect the module from physical shock or any force. In addition to damage, this may cause improper operation or damage to the module and back-light unit.
- 3. Note that polarizer is very fragile and could be easily damaged. Do not press or scratch the surface.
- 4. Do not allow drops of water or chemicals to remain on the display surface. If you have the droplets for a long time, staining and discoloration may occur.
- 5. If the surface of the polarizer is dirty, clean it using some absorbent cotton or soft cloth.
- 6. The desirable cleaners are water, IPA (Isopropyl Alcohol) or Hexane. Do not use ketene type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanent damage to the polarizer due to chemical reaction.
- 7. If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, legs, or clothes, it must be washed away thoroughly with soap.
- 8. Protect the module from static; it may cause damage to the CMOS ICs.
- 9. Use fingerstalls with soft gloves in order to keep display clean during the incoming inspection and assembly process.
- 10. Do not disassemble the module.
- 11. Protection film for polarizer on the module shall be slowly peeled off just before use so that the electrostatic charge can be minimized.
- 12. Pins of I/F connector shall not be touched directly with bare hands.
- 13. Do not connect, disconnect the module in the "Power ON" condition.
- 14. Power supply should always be turned on/off by the item Power On Sequence & Power Off Sequence.

#### 8.2 Storage and Transportation

- 1. Do not leave the panel in high temperature, and high humidity for a long time. It is highly recommended to store the module with temperature from 0 to 35 °C and relative humidity of less than 70%
- 2. Do not store the TFT-LCD module in direct sunlight.
- 3. The module shall be stored in a dark place. When storing the modules for a long time, be sure to adopt effective measures for protecting the modules from strong ultraviolet radiation, sunlight, or fluorescent light.
- 4. It is recommended that the modules should be stored under a condition where no condensation is allowed. Formation of dewdrops may cause an abnormal operation or a failure of the module. In particular, the greatest possible care should be taken to prevent any module from being operated where condensation has occurred inside.
- 5. This panel has its circuitry FPC on the bottom side and should be handled carefully in order not to be stressed.